







Product Outline:

These high output reflector type Tube LEDs are available in yellow to suit customer's application. This LEDs can be use as a side emitter for directional lighting needs. With special binning technology, these LEDs are ideal for architecture lighting and special lighting needs.

Features:

- High brightness output @ 150mA
- Package Dimension = 4.0mmX2.0mmX1.5mm
- Side view package
- RoHS compliant
- · Custom Bin available upon special request

Application:

- Architecture Lighting
- Garden Lighting
- Interior Lighting
- Special application lighting

Compliance and Certification:

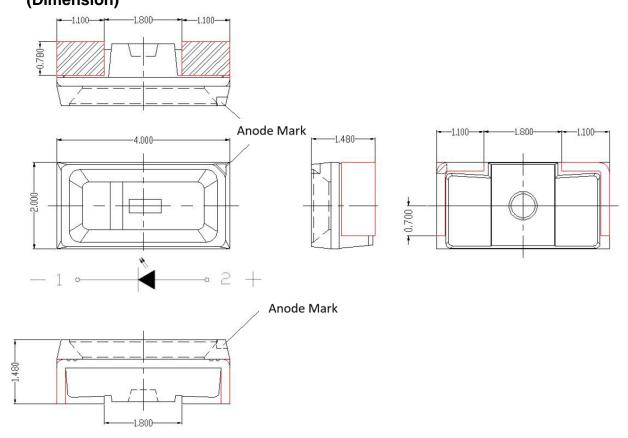






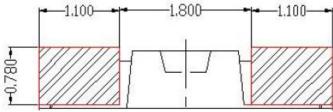


Mechanical Property: (Dimension)



^{*} All dimensions are in millimeters, * Tolerances are \pm 0.10mm.

Recommended Solder footprint:



- * All dimensions are in millimeters.
- * The LEDs is designed to be reflow soldered on to a PCB. IF dip soldered that QL cannot guarantee its reliability.
- * Reflow soldering must not be performed more than twice.



Characteristics

■ Absolute Maximum Ratings

(Ta=25°C)

	, ,		
Parameter	Symbol	Rating	Unit
DC Forward Current	lf	150	mA
Power Dissipation	Pd	0.5	W
Pulse Forward Current	Ifp	180	mA
LED Junction Temperature	TJ	120	$^{\circ}$
Storage Temperature	Tstg	-40 ~ 100	$^{\circ}$
Operation Temperature	Topr	-40 ~ 85	$^{\circ}$
Soldering Temperature	Tsol	260 < 5 sec	°
ESD HBM	ESD	4000	V
Thermal Resistance	Rth junction	20	°C/w

⁽¹⁾ Proper current rating must be observed to maintain junction temperature below maximum at all time

Electrical / Optical Characteristic

(Ta=25 oC)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	Vf		2.0		2.6	V
Brightness		150mA	20	26		lm
View Angle	θ			120		deg
Reverse current	lr	Vr = 5V		10		uA
Dominant Wavelength			588		596	nm

- (1) Tolerance of measurement: VF=+/- 0.1V
- (2) The CRI tolerance is ±2.
- (3) Thermal resistance is calculated from junction to solder



⁽²⁾ IFP Condition: $t < 100 \mu s$; D = 0.001; Ta= 25 °C



■ Specification

Wavelength Bin:

Rank @ 150mA			
Code name	Min.	Max.	Units
A11	588	590	
A21	590	592	
A31	592	594	nm
A41	594	596	

The forward voltage tolerance is ± 1 nm

Forward Voltage (V_F) Bin:

VF Rank @ 150mA			
Code name	Min.	Max.	Units
RS	2.0	2.2	
TU	2.2	2.4	V
VW	2.4	2.6	

The forward voltage tolerance is $\pm 0.1V$

Luminous Intensity Bin:

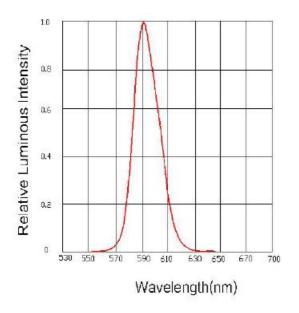
Intensity Rank (Im) @ 150mA			
Code name	Min.	Max.	Units
QJ	20	22.5	
QK	22.5	25	Im
QL	25	28	lm
QM	28	31.5	

Luminous intensity tolerance is ± 7%

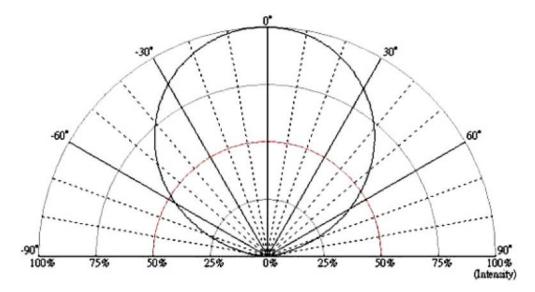


■ Characteristic Curves

(1) Color Spectrum



(2). Typical Representative Spatial Radiation Pattern

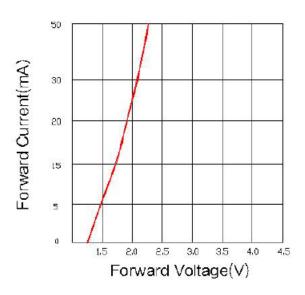




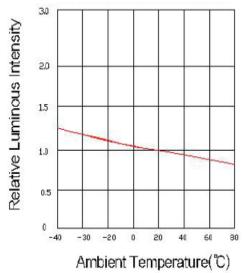


(3). Forward Current vs Forward Voltage

Forward Voltage VS.Forward Current



(4). Ambient Temp vs Relative Intensity





■ Reliability test:

No	Item	Condition	Time/Cycle	Sample size
1	Steady State Operating Life of Room Temperature	25 [°] C Operating	1000 Hrs	20 pcs
2	Steady State Operating Life of Low Temperature -40°C	-40°C Operating	1000 Hrs	20 pcs
3	Steady State Operating Life of Low Temperature $60^{\circ}\!\mathbb{C}$	60°C Operating	1000 Hrs	20 pcs
4	Steady State Operating Life of Low Temperature $85^{\circ}\!\mathbb{C}$	85°C Operating	1000 Hrs	20 pcs
5	Low temperature storage -40°C	-40°C Storage	1000 Hrs	20 pcs
6	High temperature storage 100℃	100°C Storage	1000 Hrs	20 pcs
7	Steady State Operating Life of High Humidity Heat 60°C 90%	60°C/90% Operating	1000 Hrs	20 pcs
8	Steady State Pulse Operating Life Condition	25°C10Hz duty=1/10 Operating	200 Cycle	20 pcs
9	Resistance to soldering heat on PCB (JEDEC MSL3)	pre-store@60°ℂ, 60%RH for 52hrs Tsld max.=260 10sec	3 Times	20 pcs
10	Heat Cycle Test (JEDEC MRC)	25℃ ~65℃ ~-10℃ , 90%RH, 24hr/1cycle	10 Cycle	20 pcs
11	Thermal shock	-40°C/ 20minr~ 5minr~100°C /20min	300 Cycle	20 pcs

■ Judgment Criteria:

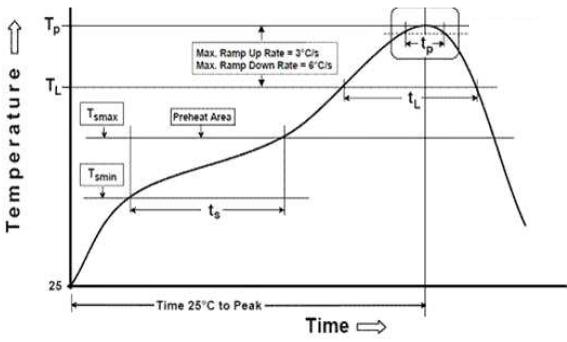
Item	Symbol	Test Condition	Judgment Criteria
Forward Voltage	Vf	60 mA	△Vf< 10%
Luminous Flux	lv	60 mA	∆lv< 30%





■ Solder Profile:

-The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



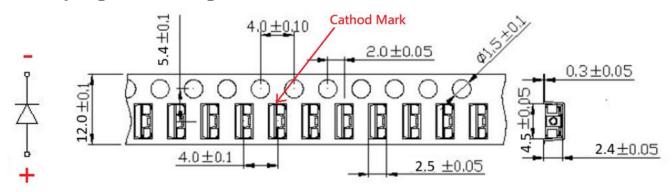
100℃	+
1000	150℃
150℃	200℃
60-120 seconds	60-120 seconds
3℃/second max.	3℃/second max.
183℃	217℃
60-150 seconds	60-150 seconds
235℃	260℃
202222da*	30 seconds*
20seconds**	30 Seconds**
6℃/second max.	6℃/second max.
6 minutes max.	8 minutes max.
	60-120 seconds 3°C/second max. 183°C 60-150 seconds 235°C 20seconds* 6°C/second max.

^{*} Tolerance for peak profile temperature (T_P) is defined as a supplier minimum and a user maximum.

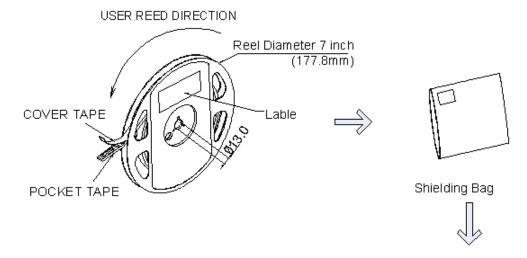


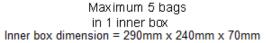


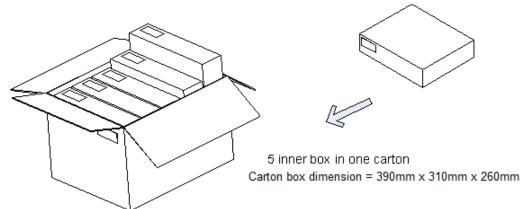
■ Taping & Packing:



Unit: mm









Labeling

Lot number: XXXXX

Iv Bin: XX Color Bin: XX Vf Bin: XX

Date Code: XXXX

QueLighting

■ Ordering Information:

Part #	Multiple Quantities	Quantity per Reel
QLSP37YH		2000 pcs



■ Revision History:

Revision Date:	Changes:	Version #:
10-30-2024	Initial release	1.0